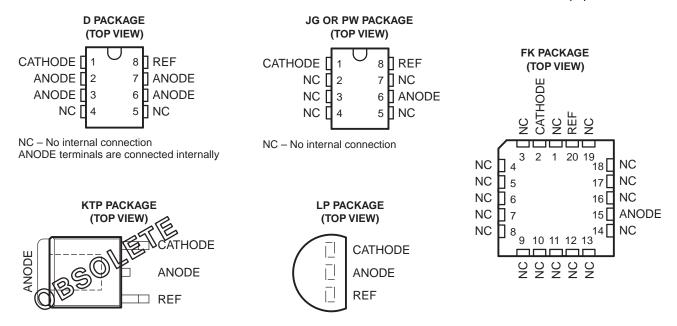


FEATURES

- 0.4% Initial Voltage Tolerance
- 0.2-Ω Typical Output Impedance
- Fast Turnon...500 ns

- Sink Current Capability...1 mA to 100 mA
- Low Reference Current (REF)
- Adjustable Output Voltage...V_{I(ref)} to 36 V



DESCRIPTION/ORDERING INFORMATION

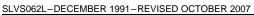
The TL1431 is a precision programmable reference with specified thermal stability over automotive, commercial, and military temperature ranges. The output voltage can be set to any value between V_{l(ref)} (approximately 2.5 V) and 36 V with two external resistors (see Figure 16). This device has a typical output impedance of 0.2 Ω . Active output circuitry provides a very sharp turnon characteristic, making the device an excellent replacement for Zener diodes and other types of references in applications such as onboard regulation, adjustable power supplies, and switching power supplies.

The TL1431C is characterized for operation over the commercial temperature range of 0°C to 70°C. The TL1431Q is characterized for operation over the full automotive temperature range of -40°C to 125°C. The TL1431M is characterized for operation over the full military temperature range of -55°C to 125°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. PowerFLEX is a trademark of Texas Instruments.

TL1431 PRECISION PROGRAMMABLE REFERENCE



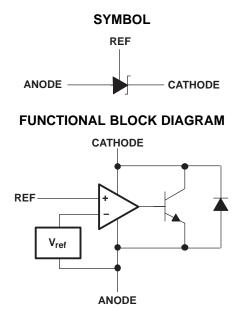


ORDERING INFORMATION⁽¹⁾

T _A	PAC	KAGE ⁽²⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	PowerFLEX [™] – KTP	Reel of 3000	TL1431CKTPR	OBSOLETE	
	SOIC – D	Tube of 75	TL1431CD	- 1431C	
	50IC - D	Reel of 2500	TL1431CDR	- 14310	
0°C to 70°C		Bulk of 1000	TL1431CLP	TI 4 404 C	
	TO-226 / TO-92 – LP	Reel of 2000	TL1431CLPR	- TL1431C	
		Tube of 150	TL1431CPW	T4 404	
	TSSOP – PW	Reel of 2000	TL1431CPWR	- T1431	
	0010 D	Tube of 75	TL1431QD	TI 4 404 O.D.	
4000 1- 40500	SOIC – D	Reel of 2500	TL1431QDR	- TL1431QD	
–40°C to 125°C		Tube of 150	TL1431QPW		
	TSSOP – PW	Reel of 2000	TL1431QPWR	- T1431QPW	
5500 to 40500	CDIP – JG	Tube of 50	TL1431MJG	TL1431MJG	
–55°C to 125°C	LCCC – FK	Tube of 55	TL1431MFK	TL1431MFK	

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

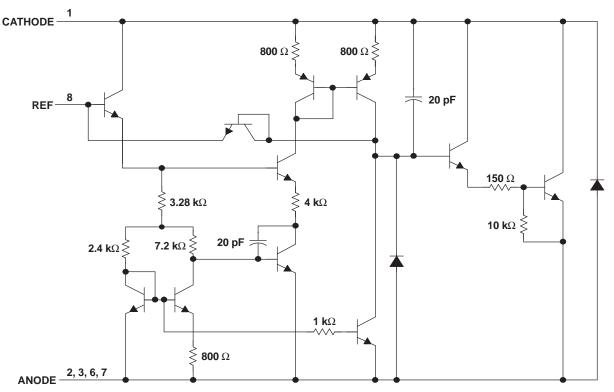
(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



2



EQUIVALENT SCHEMATIC



Α. All component values are nominal.

Pin numbers shown are for the D package. Β.

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT	
V _{KA}	Cathode voltage ⁽²⁾			37	V	
I _{KA}	Continuous cathode current range	Continuous cathode current range				
I _{I(ref)}	Reference input current range	-0.05	10	mA		
		D package		97		
θ_{JA}	Package thermal impedance ⁽³⁾⁽⁴⁾	LP package		140	°C/W	
		PW package		149		
0	Package thermal impedance ⁽⁵⁾⁽⁶⁾	FK package		5.61	°C/W	
θ _{JC}	Fackage mermai impedance and	JG package		14.5	C/VV	
TJ	Operating virtual junction temperature			150	°C	
	Lead temperature	1,6 mm (1/16 in) from case for 10 s		260	°C	
T _{stg}	Storage temperature range	-65	150	°C		

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

All voltage values are with respect to ANODE, unless otherwise noted. (2)

(3)

(4)

Maximum power dissipation is a function of $T_{J(max)}$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_{J(max)} - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability. The package thermal impedance is calculated in accordance with JESD 51-7. Maximum power dissipation is a function of $T_{J(max)}$, θ_{JC} , and T_C . The maximum allowable power dissipation at any allowable case temperature is $P_D = (T_{J(max)} - T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of 150°C can affect reliability. (5)

The package thermal impedance is calculated in accordance with MIL-STD-883. (6)



Recommended Operating Conditions

			MIN	MAX	UNIT	
V _{KA}	Cathode voltage		V _{I(ref)}	36	V	
I _{KA}	Cathode current		1	100	mA	
		TL1431C	0	70		
T _A	Operating free-air temperature	TL1431Q	-40	125	°C	
		TL1431M	-55	125		

Electrical Characteristics

at specified free-air temperature, $I_{KA} = 10$ mA (unless otherwise noted)

		TEST CONDITIONS	T _A ⁽¹⁾	TEST	Т	L1431C		UNIT	
	PARAMETER	TEST CONDITIONS	IA''	CIRCUIT	MIN	ТҮР	MAX	UNIT	
V	Reference input voltage	$\mathcal{M} = \mathcal{M}$	25°C	Eiguro 1	2490	2500	2510	mV	
V _{I(ref)}	Reference input voltage	$V_{KA} = V_{I(ref)}$	Full range	Figure 1	2480		2520	IIIV	
V _{I(dev)}	Deviation of reference input voltage over full temperature range ⁽²⁾	$V_{KA} = V_{I(ref)}$	Full range	Figure 1		4	20	mV	
$\frac{\Delta V_{\text{I(ref)}}}{\Delta V_{\text{KA}}}$	Ratio of change in reference input voltage to the change in cathode voltage	$\Delta V_{KA} = 3 V \text{ to } 36 V$	Full range	Figure 2		-1.1	-2	mV/V	
	Reference input current	R1 = 10 kΩ, R2 = ∞	25°C	Figure 2		1.5	2.5	μA	
I _{I(ref)}	Reference input current	$KI = 10 K\Omega, KZ = \infty$	Full range	Figure 2			3	μΑ	
I _{I(dev)}	Deviation of reference input current over full temperature range ⁽²⁾	R1 = 10 kΩ, R2 = ∞	Full range	Figure 2		0.2	1.2	μA	
I _{min}	Minimum cathode current for regulation	V _{KA} = V _{I(ref)}	25°C	Figure 1		0.45	1	mA	
	Off-state cathode current		25°C	Figure 3		0.18	0.5	μA	
l _{off}		$V_{KA} = 36 V, V_{I(ref)} = 0$	Full range	rigule 3			2		
z _{KA}	Output impedance ⁽³⁾	$V_{KA} = V_{I(ref)}, f \le 1 \text{ kHz},$ $I_{KA} = 1 \text{ mA to 100 mA}$	25°C	Figure 1		0.2	0.4	Ω	

Full range is 0°C to 70°C for C-suffix devices. (1)

The deviation parameters V_{I(dev)} and I_{I(dev)} are defined as the differences between the maximum and minimum values obtained over the (2)rated temperature range. The average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the reference input voltage average full-range temperature coefficient of the range temperature coefficient of temperatur

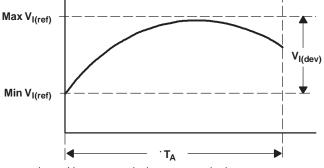
$$\alpha_{v/(ref)} \left| \left(\frac{ppm}{\circ C} \right) = \frac{\left(\frac{V_{I(dev)}}{V_{I(ref)} \text{ at } 25^{\circ}} \right)}{T}$$

where:

4

 ΔT_A is the rated operating temperature range of the device.

× 10⁶



 $\alpha_{VI(ref)}$ is positive or negative, depending on whether minimum $V_{I(ref)}$ or maximum $V_{I(ref)}$, respectively, occurs at the lower temperature. The output impedance is defined as: $|z_{\kappa A}| = \frac{\Delta V_{\kappa A}}{\Delta I_{\kappa A}}$

(3)

When the device is operating with two external resistors (see Figure 2), the total dynamic impedance of the circuit is given by: $|z'| = \frac{\Delta V}{\Delta I}$, which is approximately equal to $|z_{\kappa k}| \left(1 + \frac{R1}{R2}\right)$



Electrical Characteristics

at specified free-air temperature, $I_{KA} = 10$ mA (unless otherwise noted)

		TEST CONDITIONS	T _A ⁽¹⁾	TEST	Т	L1431Q		т	L1431M		UNIT
	PARAMETER	TEST CONDITIONS	IA	CIRCUIT	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
			25°C		2490	2500	2510	2475	2500	2540	
V _{I(ref)}	Reference input voltage	$V_{KA} = V_{I(ref)}$	Full range	Figure 1	2470		2530	2460		2550	mV
V _{I(dev)}	Deviation of reference input voltage over full temperature range ⁽²⁾	$V_{KA} = V_{I(ref)}$	Full range	Figure 1		17	55		17	55 ⁽³⁾	mV
$\frac{\Delta V_{\text{I(ref)}}}{\Delta V_{\text{KA}}}$	Ratio of change in reference input voltage to the change in cathode voltage	$\Delta V_{KA} = 3 V \text{ to } 36 V$	Full range	Figure 2		-1.1	-2		-1.1	-2	mV/V
			25°C			1.5	2.5		1.5	2.5	
I _{I(ref)}	Reference input current	R1 = 10 kΩ, R2 = ∞	Full range	Figure 2			4			5	μA
I _{I(dev)}	Deviation of reference input current over full temperature range ⁽²⁾	R1 = 10 kΩ, R2 = ∞	Full range	Figure 2		0.5	2		0.5	3 ⁽³⁾	μA
I _{min}	Minimum cathode current for regulation	$V_{KA} = V_{I(ref)}$	25°C	Figure 1		0.45	1		0.45	1	mA
	Off-state cathode		25°C			0.18	0.5		0.18	0.5	
I _{off}	current	$V_{KA} = 36 \text{ V}, V_{\text{I(ref)}} = 0$	Full range	Figure 3			2			2	μA
z _{KA}	Output impedance ⁽⁴⁾	$V_{KA} = V_{I(ref)}, f \le 1 \text{ kHz}, I_{KA} = 1 \text{ mA to } 100 \text{ mA}$	25°C	Figure 1		0.2	0.4		0.2	0.4	Ω

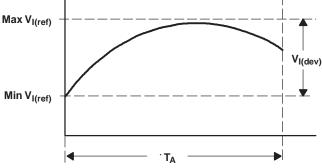
Full range is -40°C to 125°C for Q-suffix devices and -55°C to 125°C for M-suffix devices. (1)

The deviation parameters V_{I(dev)} and I_{I(dev)} are defined as the differences between the maximum and minimum values obtained over the (2)rated temperature range. The average full-range temperature coefficient of the reference input voltage avlicef) is defined as:

$$\left| \alpha_{\text{vi(ref)}} \right| \left(\frac{\text{ppm}}{^{\circ}\text{C}} \right) = \frac{\left(\frac{^{\circ}\text{Vi(dev)}}{^{\circ}\text{Vi(ref)} \text{ at } 25^{\circ}\text{C}} \right) \times 10}{T_{\text{A}}}$$

where:

 ΔT_A is the rated operating temperature range of the device.



 $\alpha_{VI(ref)}$ is positive or negative, depending on whether minimum $V_{I(ref)}$ or maximum $V_{I(ref)}$, respectively, occurs at the lower temperature. On products compliant to MIL-PRF-38535, this parameter is not production tested. The output impedance is defined as: $|z_{\kappa A}| = \frac{\Delta V_{\kappa A}}{\Delta I_{\kappa A}}$ (3)

(4)

When the device is operating with two external resistors (see Figure 2), the total dynamic impedance of the circuit is given by: $|z'| = \frac{\Delta V}{\Delta I}$, which is approximately equal to $|Z_{KA}| \left(1 + \frac{R1}{R2}\right)$

PARAMETER MEASUREMENT INFORMATION

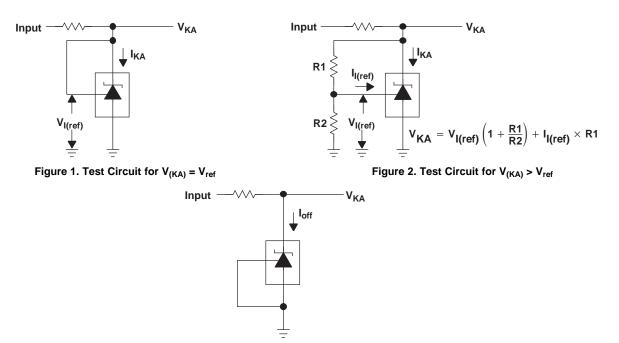


Figure 3. Test Circuit for I_{off}

TYPICAL CHARACTERISTICS

Data at high and low temperatures are applicable only within the recommended operating free-air temperature ranges of the various devices.

Table of Graphs

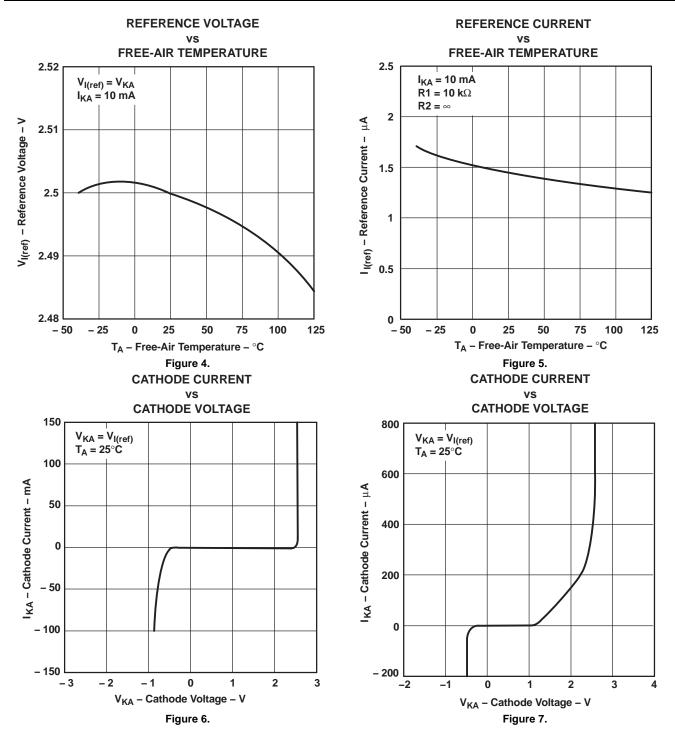
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6



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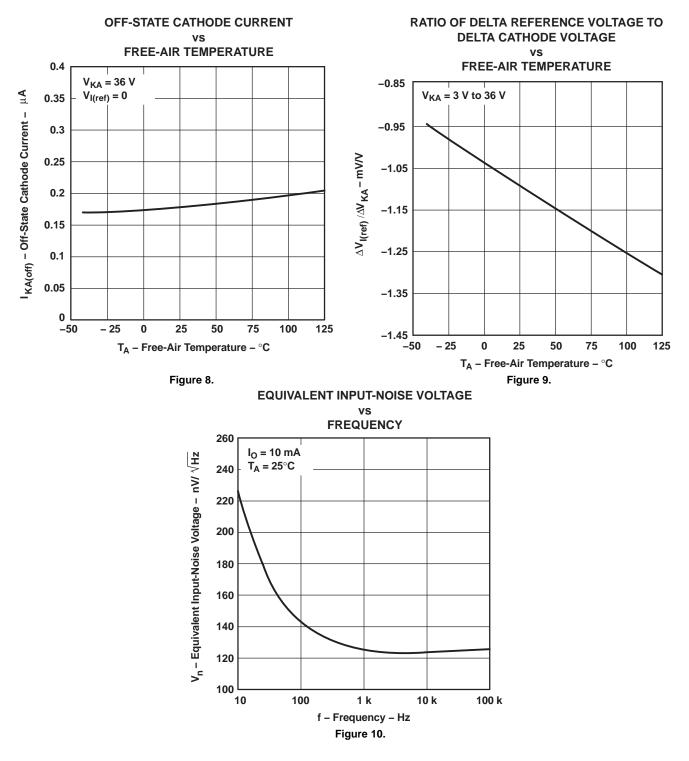
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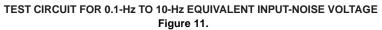


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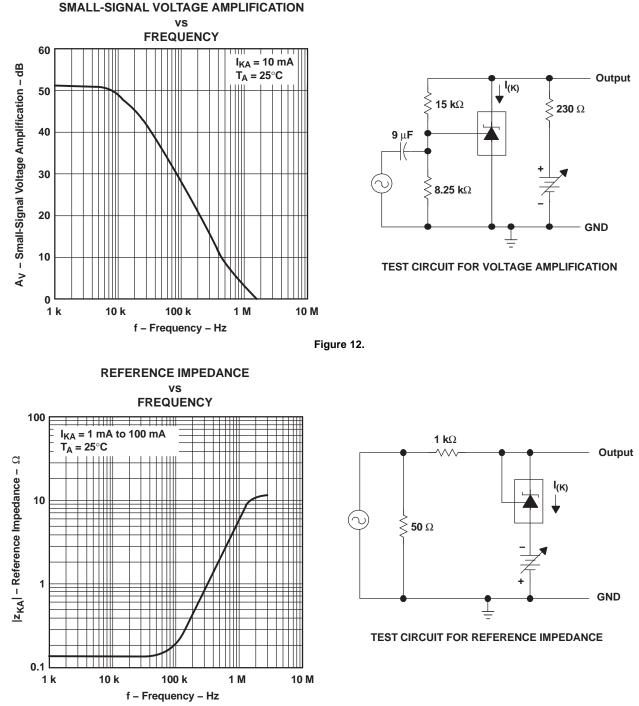
8

EQUIVALENT INPUT-NOISE VOLTAGE **OVER A 10-SECOND PERIOD** 6 5 $\textbf{V}_{\textbf{n}}$ – Equivalent Input-Noise Voltage – $\mu\textbf{V}$ 4 3 2 1 0 - 1 - 2 - 3 - 4 f = 0.1 to 10 Hz I_{KA} = 10 mA - 5 T_A = 25°C - 6 0 2 4 6 8 10 t – Time – s 19.1 V ≶ **1 k**Ω **2000** μ**F 910** Ω Vcc v_{cc} **500** μF *>* TL1431 (DUT) -((TLE2027 **820** Ω **1** μ**F** $A_V = 10 V/mV$ \sim TLE2027 \sim $\pmb{16}\,\Omega$ **16** Ω łt **16** Ω **2.2** μ**F** 1 μF 🗁 **160 k**Ω -33 k Ω (CRO) 1 M Ω \sim $A_V = 2 V/V$ **0.1** μ**F** < **33 k**Ω + V_{EE} V_{EE}



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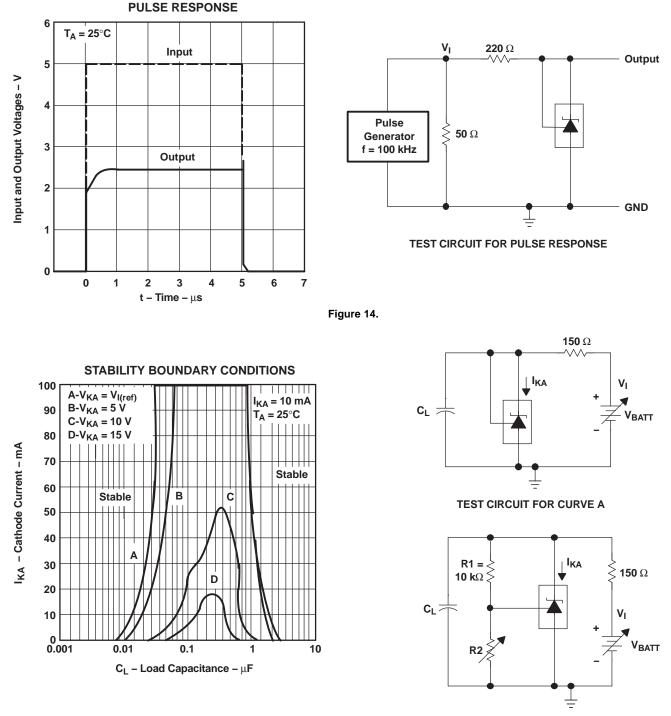




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TEST CIRCUIT FOR CURVES B, C, AND D

A. The areas under the curves represent conditions that may cause the device to oscillate. For curves B, C, and D, R2 and V+ are adjusted to establish the initial V_{KA} and I_{KA} conditions, with $C_L = 0$. V_{BATT} and C_L then are adjusted to determine the ranges of stability.

Figure 15.

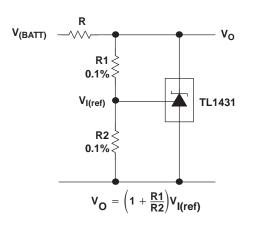
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APPLICATION INFORMATION

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A. R should provide cathode current ≥1 mA to the TL1431 at minimum V_(BATT). **Figure 16. Shunt Regulator**

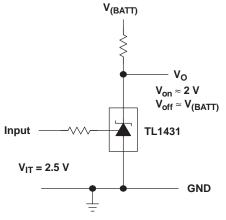
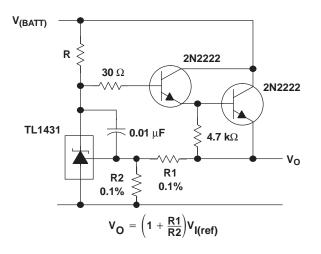


Figure 17. Single-Supply Comparator With Temperature-Compensated Threshold



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R should provide cathode current ≥1 mA to Α. the TL1431 at minimum $V_{(BATT)}$. Figure 18. Precision High-Current Series Regulator

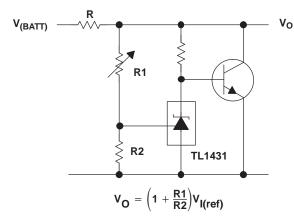


Figure 20. Higher-Current Shunt Regulator

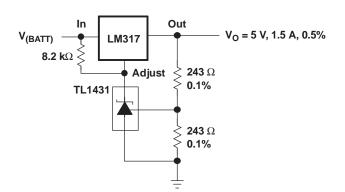


Figure 22. Precision 5-V, 1.5-A, 0.5% Regulator

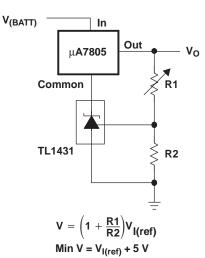
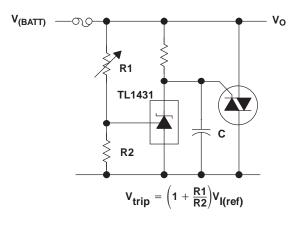
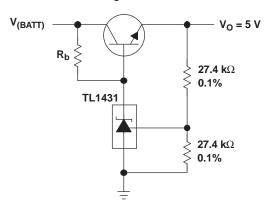


Figure 19. Output Control of a Three-Terminal Fixed Regulator



Refer to the stability boundary conditions in Α. Figure 15 to determine allowable values for C.

Figure 21. Crowbar



A. R_b should provide cathode current ≥ 1 mA to the TL1431.

Figure 23. 5-V Precision Regulator

TL1431 PRECISION PROGRAMMABLE REFERENCE

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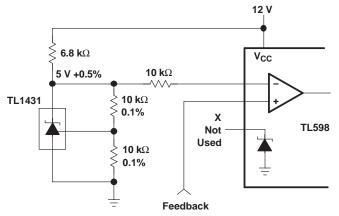
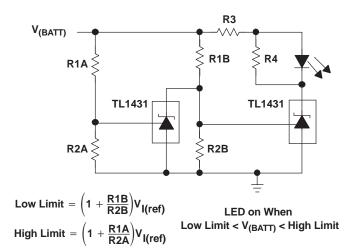
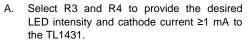


Figure 24. PWM Converter With 0.5% Reference







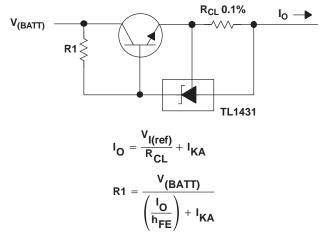


Figure 27. Precision Current Limiter

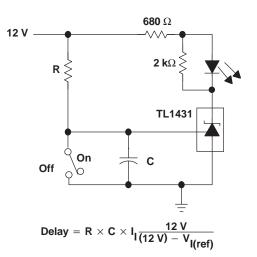


Figure 26. Delay Timer

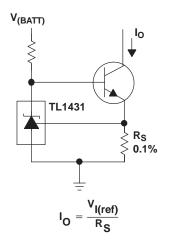


Figure 28. Precision Constant-Current Sink

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PACKAGING INFORMATION

	Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
	5962-9962001Q2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
;	5962-9962001QPA	ACTIVE	CDIP	JG	8	1	TBD	A42 SNPB	N / A for Pkg Type
	5962-9962001VPA	ACTIVE	CDIP	JG	8	1	TBD	A42 SNPB	N / A for Pkg Type
	TL1431CD	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CDE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CDR	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CDRE4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CKTPR	OBSOLETE	PFM	KTP	2		TBD	Call TI	Call TI
	TL1431CLP	ACTIVE	TO-92	LP	3	1000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
	TL1431CLPE3	ACTIVE	TO-92	LP	3	1000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
	TL1431CLPM	OBSOLETE	TO-92	LP	3		TBD	Call TI	Call TI
	TL1431CLPR	ACTIVE	TO-92	LP	3	2000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
	TL1431CLPRE3	ACTIVE	TO-92	LP	3	2000	Pb-Free (RoHS)	CU SN	N / A for Pkg Type
	TL1431CPW	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CPWE4	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CPWG4	ACTIVE	TSSOP	PW	8	150	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CPWR	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CPWRE4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431CPWRG4	ACTIVE	TSSOP	PW	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431MFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
	TL1431MFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
	TL1431MJG	ACTIVE	CDIP	JG	8	1	TBD	A42 SNPB	N / A for Pkg Type
	TL1431MJGB	ACTIVE	CDIP	JG	8	1	TBD	A42 SNPB	N / A for Pkg Type
	TL1431QD	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
	TL1431QDG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
	TL1431QDR	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
	TL1431QDRG4	ACTIVE	SOIC	D	8	2500	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Pa	ackage Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
						no Sb/Br)		
TL1431QLP	OBSOLETE	TO-92	LP	3		TBD	Call TI	Call TI
TL1431QLPR	OBSOLETE	TO-92	LP	3		TBD	Call TI	Call TI
TL1431QPWR	ACTIVE	TSSOP	PW	8 2	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
TL1431QPWRG4	ACTIVE	TSSOP	PW	8 2	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*	All dimensions are nominal												
	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	TL1431CDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
Γ	TL1431CPWR	TSSOP	PW	8	2000	330.0	12.4	7.0	3.6	1.6	8.0	12.0	Q1



PACKAGE MATERIALS INFORMATION

19-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL1431CDR	SOIC	D	8	2500	340.5	338.1	20.6
TL1431CPWR	TSSOP	PW	8	2000	346.0	346.0	29.0

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

E. Reference JEDEC MS-012 variation AA.



MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



MLCC006B - OCTOBER 1996

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004

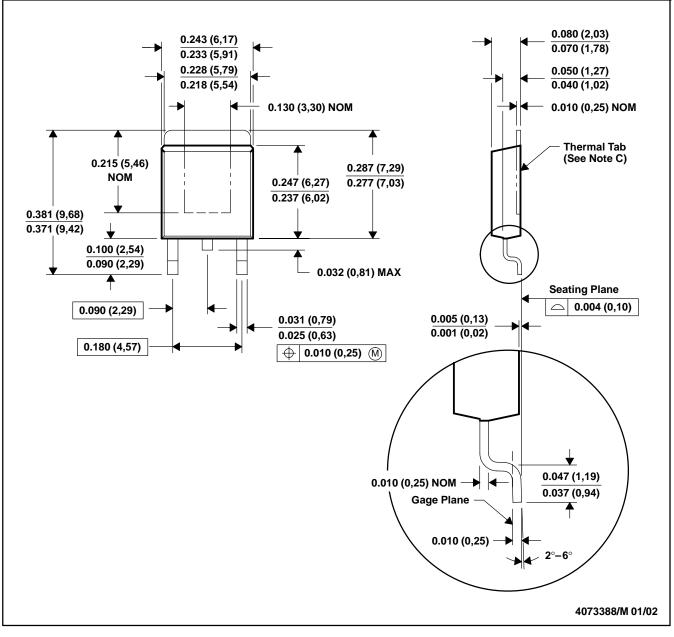


MECHANICAL DATA

MPSF001F - JANUARY 1996 - REVISED JANUARY 2002

KTP (R-PSFM-G2)

PowerFLEX[™] PLASTIC FLANGE-MOUNT PACKAGE



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. The center lead is in electrical contact with the thermal tab.
 - D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).
 - E. Falls within JEDEC TO-252 variation AC.

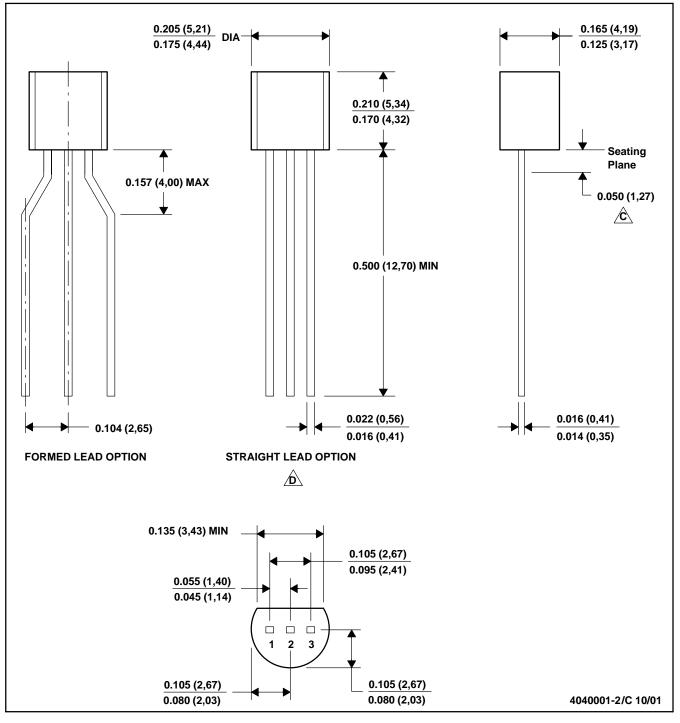
PowerFLEX is a trademark of Texas Instruments.

MECHANICAL DATA

MSOT002A - OCTOBER 1994 - REVISED NOVEMBER 2001

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



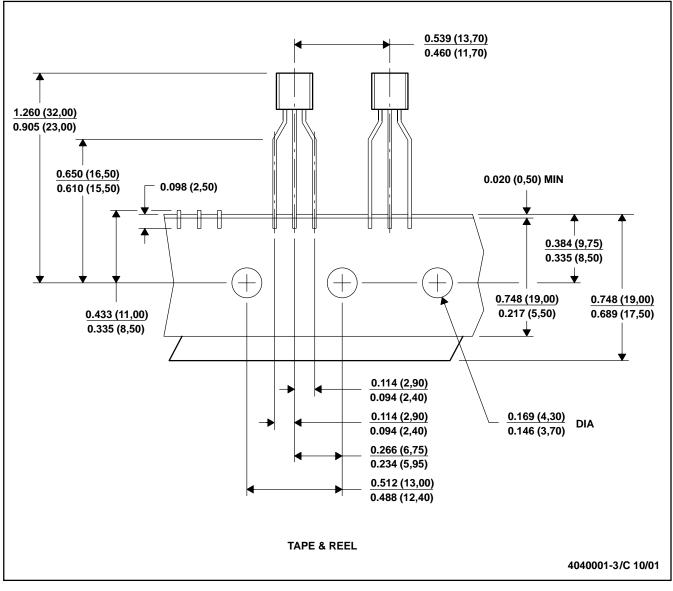
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- \underline{c} Lead dimensions are not controlled within this area
- D. FAlls within JEDEC TO -226 Variation AA (TO-226 replaces TO-92)
- E. Shipping Method:
 - Straight lead option available in bulk pack only.
 - Formed lead option available in tape & reel or ammo pack.

MSOT002A - OCTOBER 1994 - REVISED NOVEMBER 2001

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Tape and Reel information for the Format Lead Option package.



MECHANICAL DATA

MCER001A - JANUARY 1995 - REVISED JANUARY 1997



CERAMIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8



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